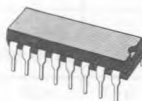


## HORIZONTAL DEFLECTION POWER DRIVER

- CONTROLLED DRIVING OF THE POWER TRANSISTOR DURING TURN ON AND OFF PHASE FOR MINIMUM POWER DISSIPATION AND HIGH RELIABILITY
- HIGH SOURCE AND SINK CURRENT CAPABILITY
- DISCHARGE CURRENT DERIVED FROM PEAK CHARGE CURRENT
- CONTROLLED DISCHARGE TIMING
- DISABLE FUNCTION FOR SUPPLY UNDER VOLTAGE AND NONSYNCHRONOUS OPERATION
- PROTECTION FUNCTION WITH HYSTERESIS FOR OVERTEMPERATURE
- OUTPUT DIODE CLAMPING
- LIMITING OF THE COLLECTOR PEAK CURRENT OF THE DEFLECTION POWER TRANSISTOR DURING TURN ON PERIOD
- SPECIAL REMOTE FUNCTION WITH DELAY TIME TO SWITCH ON THE OUTPUT

The current source characteristic of this device is adapted to the on-linear current gain behaviour of the power transistor providing a minimum power dissipation. The TDA 8140 is internally protected against short circuit and thermal overload.



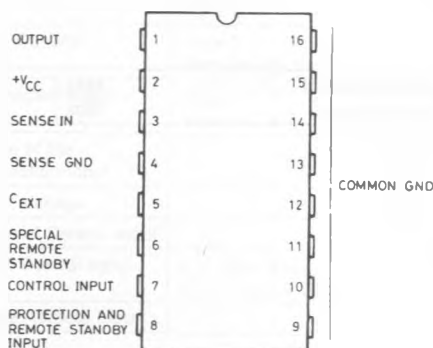
**POWERDIP**  
(8 + 8)

**ORDER CODE : TDA8140**

### DESCRIPTION

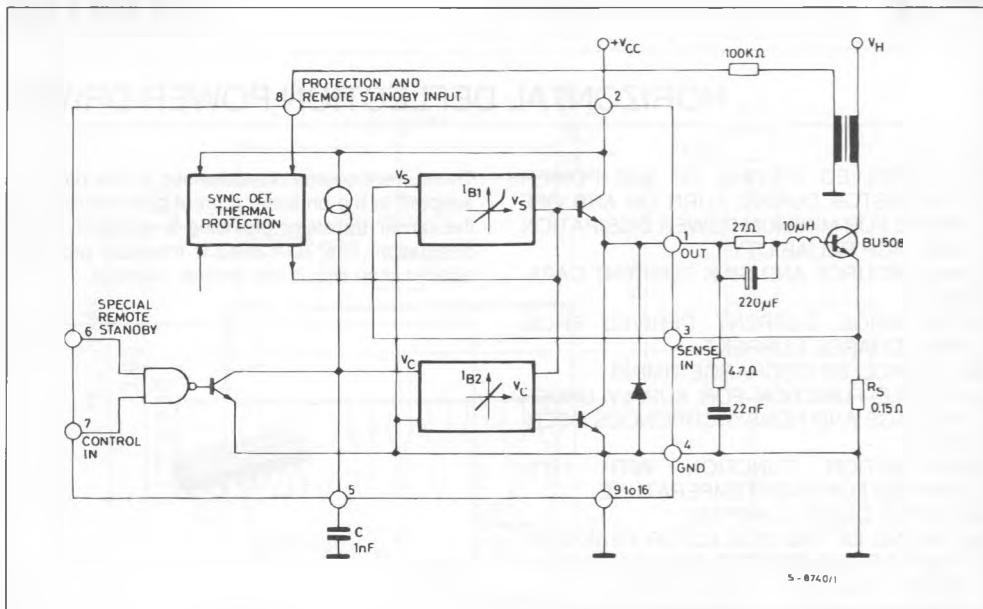
The TDA 8140 is a monolithic integrated circuit designed to drive the horizontal deflection power transistor.

### CONNECTION DIAGRAM



S-8741/1

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{CC}$	DC Supply Voltage	18	V
$I_d$	Output Current	Internally Limited	
$P_{tot}$	Power Dissipation	Internally Limited	
$T_{stg}$	Storage Temperature	- 40 to 150	°C
$T_j$	Junction Temperature	- 40 to 150	°C
$T_{op}$	Operating Temperature	0 to 70	°C

## THERMAL DATA

$R_{th\ j-amb}$	Thermal Resistance Junction-ambient	Max	70	°C/W
$R_{th\ j-case}$	Thermal Resistance Junction-case	Max	15	°C/W

## PIN FUNCTION

Pin	Name	Function
1	Output	Device Output
2	V <sub>CC</sub>	Supply Voltage
3	Sense Input	Input voltage that determines output current.
4	Sense GND	Reference Ground for Input Voltage at Sense Input
5	C <sub>EXT</sub>	Capacitor between this terminal and Sense Ground determines the current slope $dI_G/dI$ during off phase.
6	Special Remote/Standby	Low level at this input sets the device after a delay time $t_{dr}$ in the standby mode independent from control input (2nd priority) (in standard applications pin 6 must be left unconnected).
7	Control Input	High level at this input switches the BU508 off, low level switches the BU508 on.
8	Protection and Remote Standby Input	A high level at this input switches the BU508 off independent from all other inputs (1st priority).
9-16	Power Ground	Common Ground

ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 12 V, T<sub>amb</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		7		18	V
I <sub>Q</sub>	Quiescent Current	All Inputs Open	10	15	25	mA
I <sub>p0</sub>	Positive Output Current (source)		1.5			A
I <sub>n0</sub>	Negative Output Current (sink)		2			A
I <sub>o0</sub>	Positive quiescent output current forcing the output to 6 V and the sense input to ground output externally forced to 6 V.	Remote Input 1 Remote Input 0	120 50	150 80	200 100	mA mA
g <sub>ON</sub>	Transconductance ON Phase	Remote Input 1	1.8	2.0	2.2	A/V
g <sub>OFF</sub>	Transconductance OFF Phase	Remote Input 1	1.8	2.0	2.2	
g <sub>REMOTE</sub>	Transconductance Standby Mode	Remote Input 0	0.675	0.75	0.825	
I <sub>5</sub>	Current Source Pin 5	V <sub>6</sub> = 500 mV	135	165	200	μA
R <sub>INS</sub>	Sense Input Resistance	V <sub>S</sub> > 0 V <sub>S</sub> < 0	0.7 0.35	1 0.5	1.3 0.7	kΩ kΩ
I <sub>INS</sub>	Sense Input Bias Current	V <sub>S</sub> = 0 Remote Input = 1	− 200	− 300	− 400	μA
R <sub>SYN</sub>	Synchronous Detection Input Resistance	V <sub>SYN</sub> < 7 V V <sub>SYN</sub> > 7 V	30 7	60 10	150 15	kΩ kΩ
V <sub>THS</sub>	Threshold Voltage of the Synchronous Detection Input		1	1.8	2.8	V
V <sub>SYN</sub>	Sync Detect Input Voltage				30	V
V <sub>THA</sub>	Threshold Voltage of Control Input		1.5	2	2.5	V
I <sub>INA</sub>	Pull up Current of Control Input	0 < V <sub>IN</sub> < V <sub>THA</sub> V <sub>IN</sub> > V <sub>THA</sub> + 0.5 V	− 50 − 1	− 100 0	− 160 + 1	μA μA
V <sub>THB</sub>	Threshold Voltage Remote Input		1.5	2	2.5	V

## ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{INB}$	Pull up Current of the Remote Input	$0 < V_{IN} < V_{THB}$ $V_{IN} > V_{THB} + 0.5 \text{ V}$	- 50 - 1	- 100 0	- 160 + 1	$\mu\text{A}$ $\mu\text{A}$
$t_{dr}$	Remote Delay Time 1)		190	250	300	$\mu\text{s}$
$t_{don}$	On Delay Time			3	4.5	$\mu\text{s}$
$V_{CC-V_{OUT}}$	Output Voltage Drop for $I_{p0} = 1 \text{ A}$		2	2.8	3	V
$V_{CC ON}$	Supply Voltage for Device "ON"	$I_0 \geq 0$	5.8	6.4	7.0	V
$V_{CC OFF}$	Supply Voltage for Device "OFF" (output internally switched to ground)		5.6	$V_{CC ON} - 0.2 \text{ V}$	6.8	V
$V_{S \text{ limit}}$	Sense Limit Voltage 2)		0.8	0.9	1	V

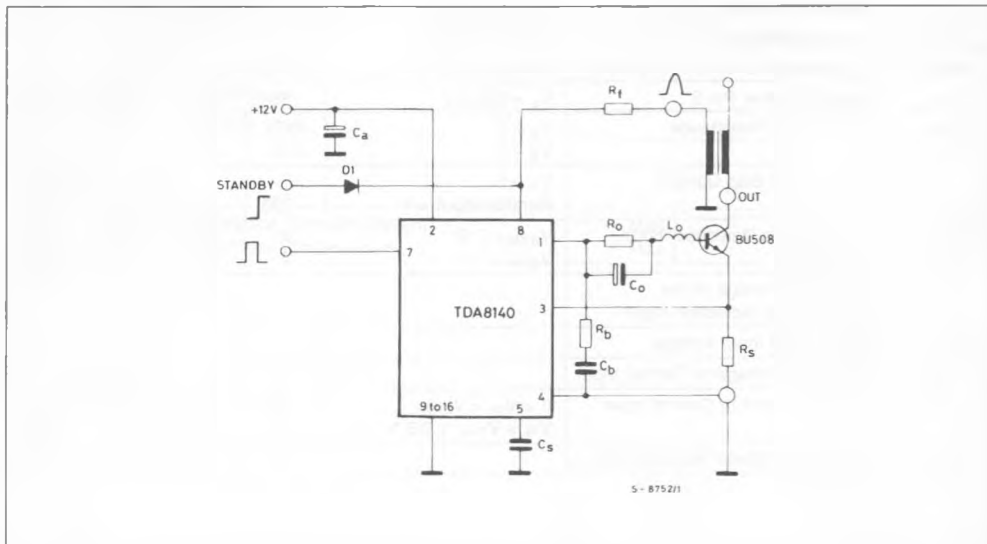
Notes : 1. When the remote input goes from HIGH to LOW the BU508 is switched off and it remains in this condition for the time  $t_d$ .  
 2. The sense input voltage  $V_S$  is internally limited and results in a limited positive output current  $I_{p0} = g V_S \text{ limit}$ . Note that due to the storage time  $t_s$  of the BU508 limiting of  $V_S$  leads to a reduced base current of the BU508 and the output current  $I_0$  is going to the positive quiescent current  $I_{0c}$ .

## TRUTH TABLE

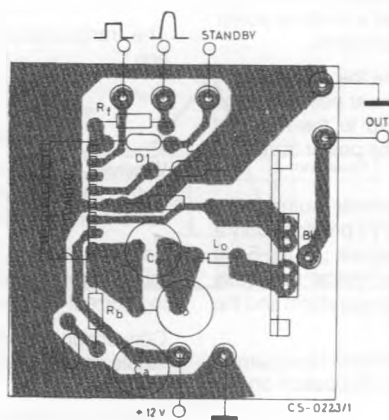
Logic Inputs		Output $I_0$		Mode
Control Input	Remote/Standby			
0 Floating or 1	Floating or 1 Floating or 1	$I_0 > 0$ $I_0 < 0$ 3)	BU508 ON BU508 OFF	Normal Function
X	0	$I_0 < 0$ 3) $0 < t < t_{dr}$	BU508 OFF	Remote/Standby Function
X	0	$I_0 > 0$ $t > t_{dr}$	BU508 ON	

3)  $I_0 < 0$  means that the sink current flows into the output to ground.

Figure 1 : Large Screen Application.



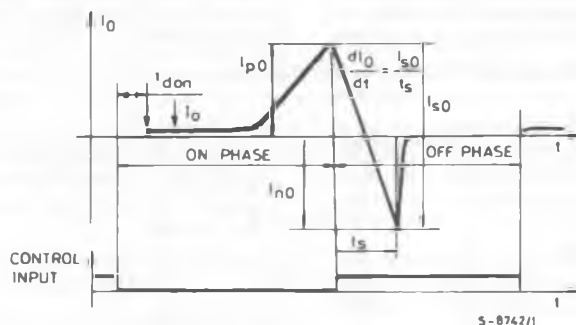
**Figure 2 :** P.C. Board and Components Layout of the Fig. 1 (1 : 1 scale).



### COMPONENTS LIST FOR TYPICAL APPLICATION

CRT	22"/26" 100°	14"/20" 90°	CRT	22"/26" 100°	14"/20" 90°
$C_a$	47 $\mu$ F	47 $\mu$ F	$R_b$	4.7 $\Omega$	4.7 $\Omega$
$R_o$	27 $\Omega$ 2W	27 $\Omega$ 1 W	$C_b$	47 nF	47 nF
$C_o$	220 $\mu$ F	220 $\mu$ F	$R_s$	0.15 $\Omega$	0.1 $\Omega$
$L_o$	10 $\mu$ H	10 $\mu$ H	$C_s$	1 nF	1 nF

**Figure 3.**



## APPLICATION INFORMATION

The conventional deflection system is shown in fig. 4 the driving circuit consists of a bipolar power transistor driven by a transformer and a medium power element plus some passive components.

During the active deflection phase the collector current of the power transistor is linear rising and the driving circuitry must be adapted to the required base current in order to ensure the power transistor saturation.

According to the limited components number the typical approach of the present TVs provides only a rough approximation of this objective ; in fig. 5 we give a comparison between the typical real base current and the ideal base current waveform and the collector waveform.

The marked area represents a useless base current which gives an additional power dissipation on the power transistor.

Furthermore during the turn-ON and turn-OFF transient phase of the chassis the power transistor is extremely stressed when the conventional network cannot guarantee the saturation ; for this reason, generally, the driving circuit must be carefully designed and is different for each deflection system.

The new approach, using the TDA 8140, overcomes these restrictions by means of a feedback principle.

As shown in fig. 5, at each instant of time the ideal base current of the power transistor results from its collector current divided by such current gain which ensure the saturation ; thus the required base current  $I_b$  can be easily generated by a feedback trans-conductance amplifier  $g_m$  which senses the deflection current across the resistor  $R_s$  at the emit-

ter of the power transistor and delivers :

$$I_b = R_S \cdot g_m \cdot I_e$$

The transconductance must only fulfill the condition :

$$\frac{1}{1 + \beta_{\min}} \cdot \frac{1}{R_S} < g_m < \frac{1}{R_S}$$

Where  $\beta_{\min}$  is the minimum current gain of the transistor. This method always ensures the correct base current and acts time independent on principle.

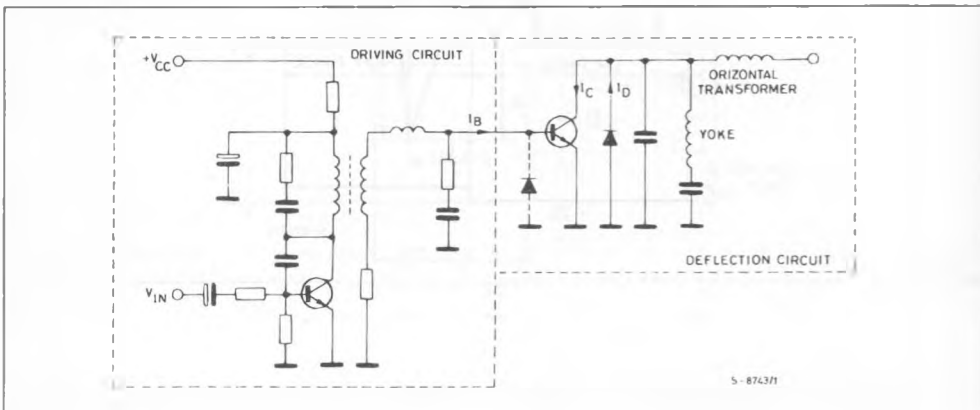
For the turn-OFF, the base of the power transistor must be discharged by a quasi linear time decreasing current as given in fig. 3.

Conventional driver systems inherently result into a stable condition with a constant peak current magnitude.

This is due to the constant base charge in the turn-ON phase independent from the collector current ; hence a high peak current results into a low storage time of the transistor because the excess base charge is a minimum and vice versa. In the active deflection the required function, high peak current-fast switch-OFF and low peak current-slow switch-OFF, is obtained by a controlled base discharge current for the power transistor ; the negative slope of this ramp is proportional to the actual sensed current.

As a result, the active driving system even improves the sharpness of vertical lines on the screen compared with the traditional solution due to the increased stability factor of the loop represented as the variation of the storage time versus the collector peak current.

**Figure 4 : Conventional Horizontal Deflection System For TVs.**





If for any reason, the junction temperature increases up to 150 °C, the thermal shut-down simply switched-OFF the device.

Figure 6 : Block Diagram of the Integrated Horizontal Driver.

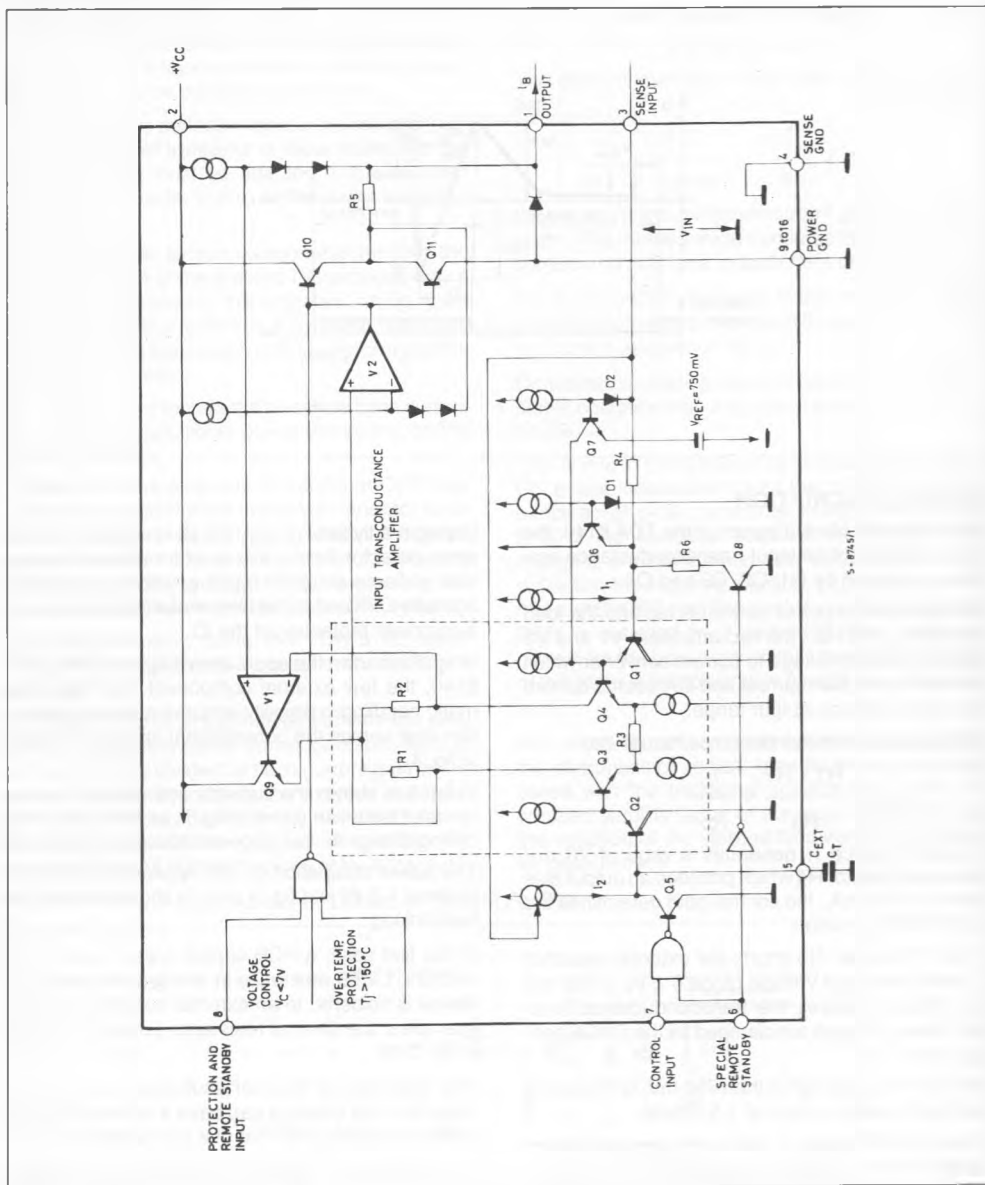




Figure 7 : Integrated Horizontal Driver.

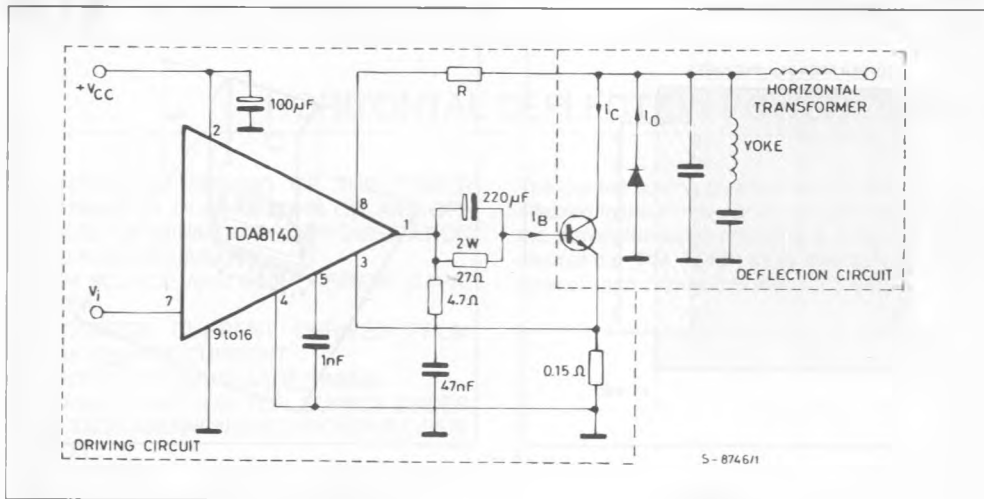
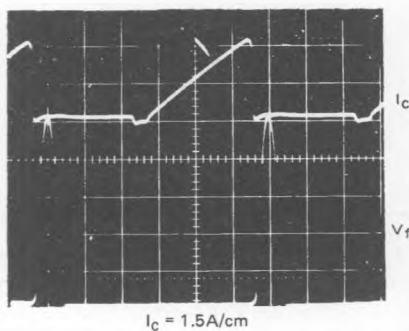
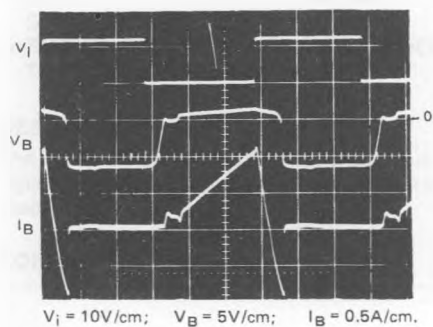
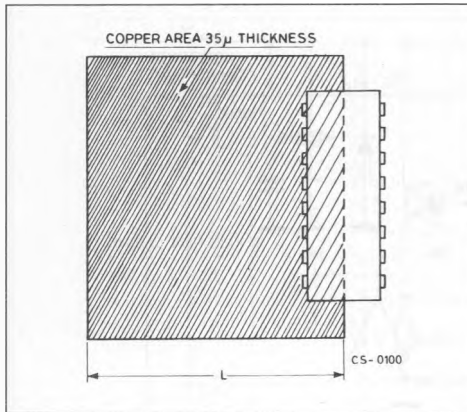


Figure 8 : Signal Diagrams of the Driver Circuits.



**Figure 9** : Example of Heatsink Using P.C Board Copper (L = 65 mm).



**Figure 10** : Example of an External Heatsink.

